
HAT2028R/HAT2028RJ

Silicon N Channel Power MOS FET
High Speed Power Switching

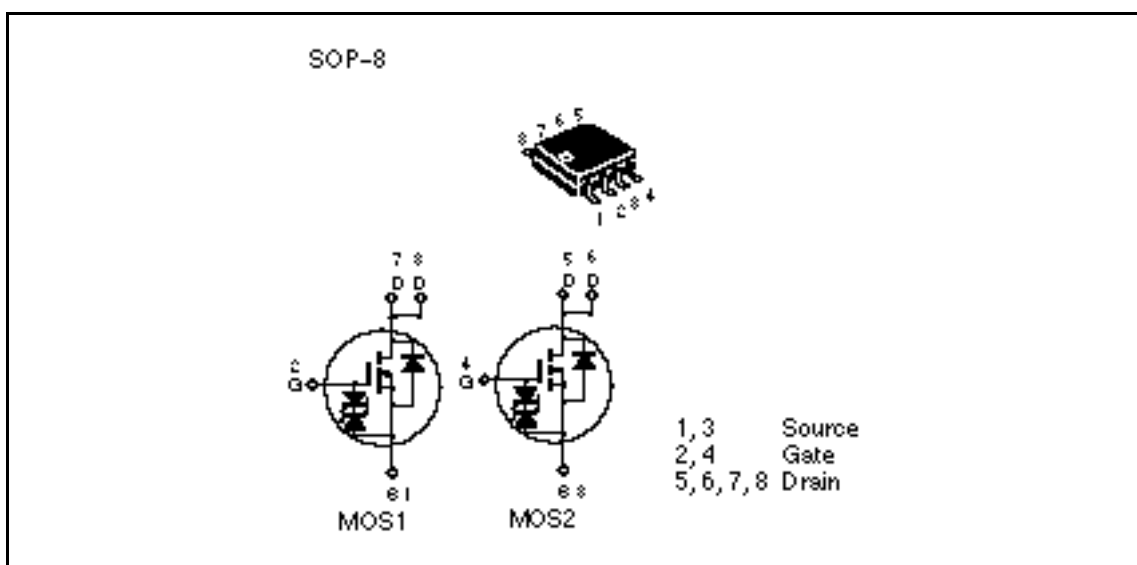
HITACHI

ADE-208-524C (Z)
4th. Edition
February 1999

Features

- For Automotive Application (at Type Code "J ")
- Low on-resistance
- Capable of 4 V gate drive
- High density mounting

Outline



HAT2028R/HAT2028RJ

Absolute Maximum Ratings (Ta = 25°C)

Item	Symbol	Ratings	Unit
Drain to source voltage	V_{DSS}	60	V
Gate to source voltage	V_{GSS}	± 20	V
Drain current	I_D	4	A
Drain peak current	$I_{D(pulse)}$ ^{Note1}	32	A
Body-drain diode reverse drain current	I_{DR}	4	A
Avalanche current	HAT2028R I_{AP} ^{Note4}	—	—
	HAT2028RJ	4	A
Avalanche energy	HAT2028R E_{AR} ^{Note4}	—	—
	HAT2028RJ	1.37	mJ
Channel dissipation	P_{ch} ^{Note2}	2	W
Channel dissipation	P_{ch} ^{Note3}	3	W
Channel temperature	T_{ch}	150	°C
Storage temperature	T_{stg}	−55 to +150	°C

Note: 1. PW 10μs, duty cycle 1 %
 2. 1 Drive operation ; When using the glass epoxy board (FR4 40 x 40 x 1.6 mm), PW 10s
 3. 2 Drive operation ; When using the glass epoxy board (FR4 40 x 40 x 1.6 mm), PW 10s
 4. Value at T_{ch}=25°C, R_g 50

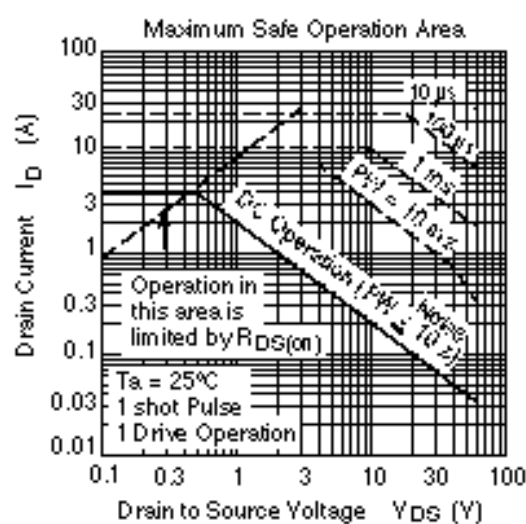
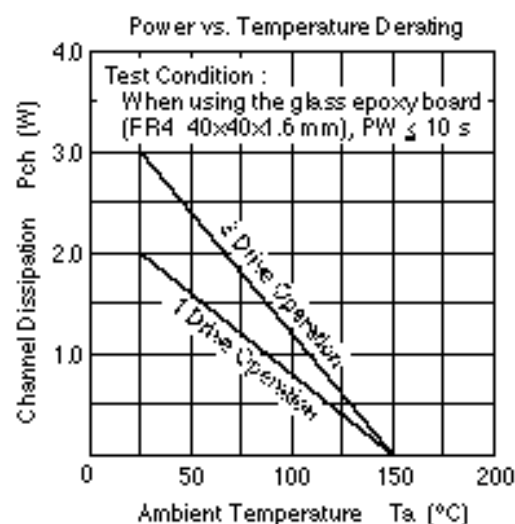
HAT2028R/HAT2028RJ

Electrical Characteristics (Ta = 25°C)

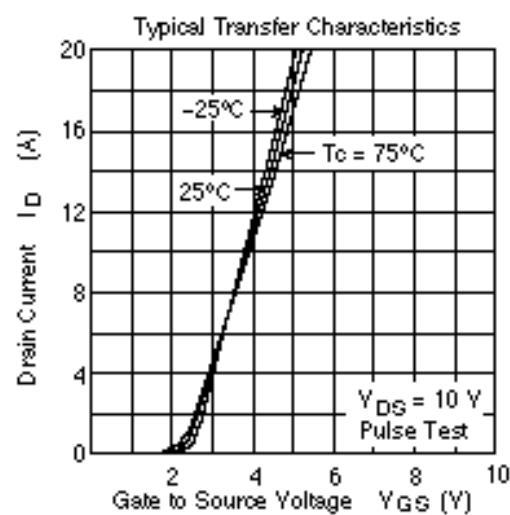
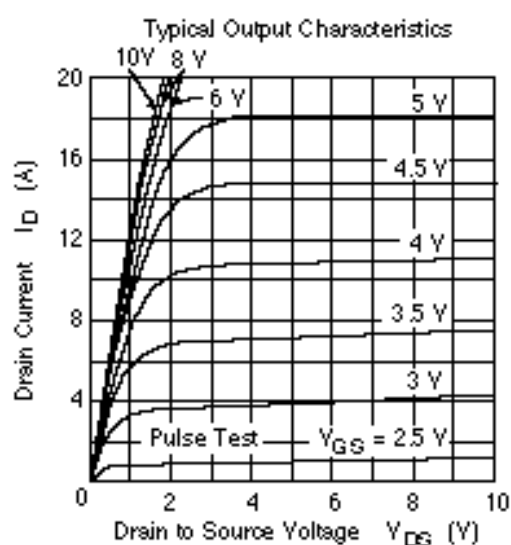
Item		Symbol	Min	Typ	Max	Unit	Test Conditions
Drain to source breakdown voltage		$V_{(BR)DSS}$	60	—	—	V	$I_D = 10mA, V_{GS} = 0$
Gate to source breakdown voltage		$V_{(BR)GSS}$	±20	—	—	V	$I_G = \pm 100\mu A, V_{DS} = 0$
Gate to source leak current		I_{GSS}	—	—	±10	μA	$V_{GS} = \pm 16V, V_{DS} = 0$
Zero gate voltage	HAT2028R	I_{DSS}	—	—	1	μA	$V_{DS} = 60V, V_{GS} = 0$
drain current	HAT2028RJ	I_{DSS}	—	—	0.1	μA	
Zero gate voltage	HAT2028R	I_{DSS}	—	—	—	μA	$V_{DS} = 48V, V_{GS} = 0$
drain current	HAT2028RJ	I_{DSS}	—	—	10	μA	Ta=125°C
Gate to source cutoff voltage		$V_{GS(off)}$	1.3	—	2.3	V	$V_{DS} = 10V, I_D = 1mA$
Static drain to source on state		$R_{DS(on)}$	—	0.08	0.1		$I_D = 2A, V_{GS} = 10V$ ^{Note5}
resistance		$R_{DS(on)}$	—	0.12	0.16		$I_D = 2A, V_{GS} = 4V$ ^{Note5}
Forward transfer admittance		$ y_{fs} $	3.3	5	—	S	$I_D = 2A, V_{DS} = 10V$ ^{Note5}
Input capacitance		C_{iss}	—	280	—	pF	$V_{DS} = 10V$
Output capacitance		C_{oss}	—	150	—	pF	$V_{GS} = 0$
Reverse transfer capacitance		C_{rss}	—	55	—	pF	f = 1MHz
Turn-on delay time		$t_{d(on)}$	—	15	—	ns	$V_{GS} = 4V, I_D = 2A$
Rise time		t_r	—	100	—	ns	$V_{DD} = 30V$
Turn-off delay time		$t_{d(off)}$	—	35	—	ns	
Fall time		t_f	—	45	—	ns	
Body-drain diode forward voltage		V_{DF}	—	0.88	1.15	V	$I_F = 4A, V_{GS} = 0$ ^{Note5}
Body-drain diode reverse recovery time		t_{rr}	—	40	—	ns	$I_F = 4A, V_{GS} = 0$ diF/ dt =50A/μs

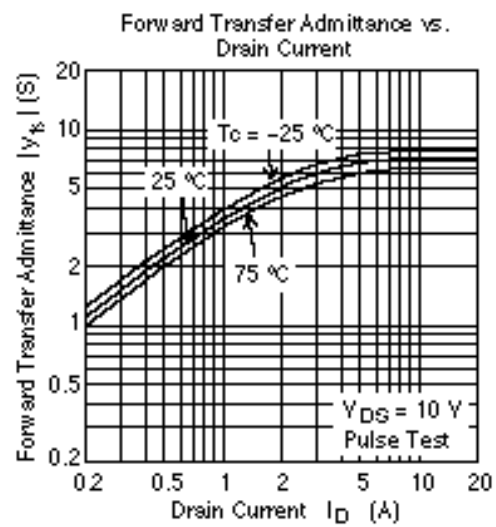
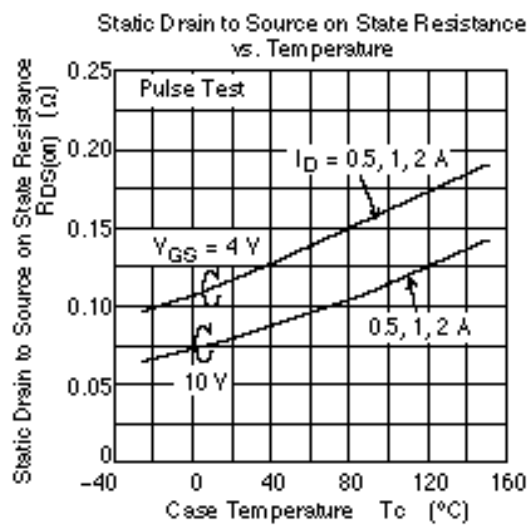
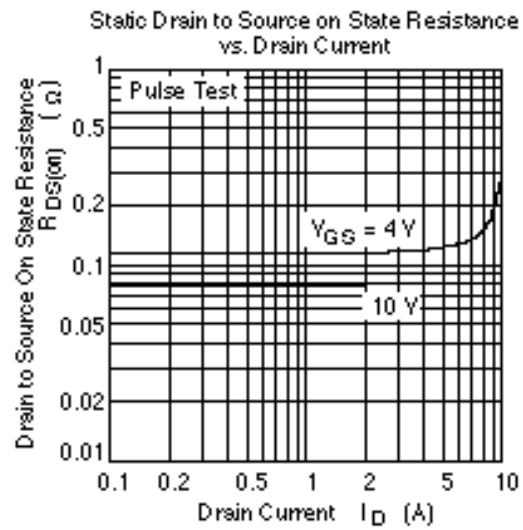
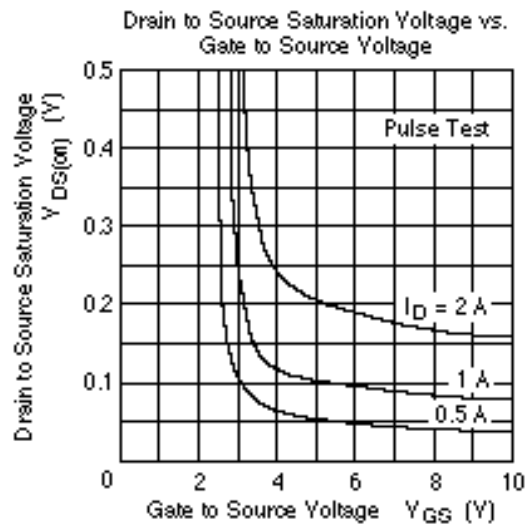
Note: 5. Pulse test

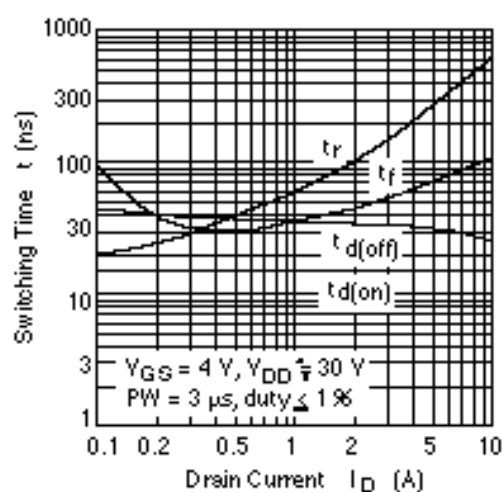
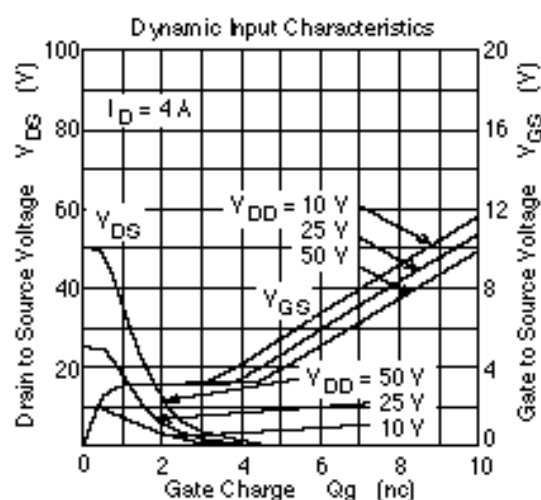
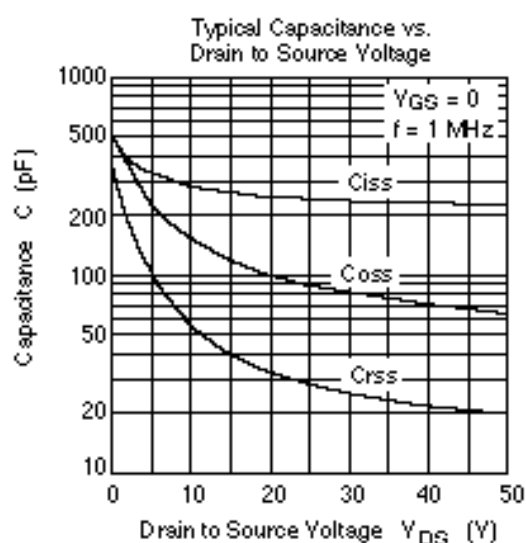
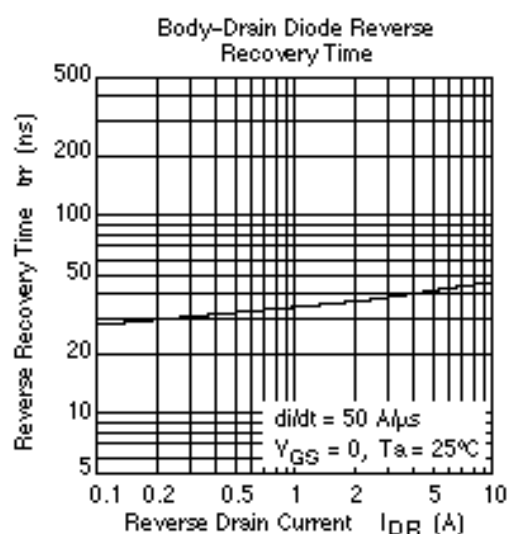
Main Characteristics

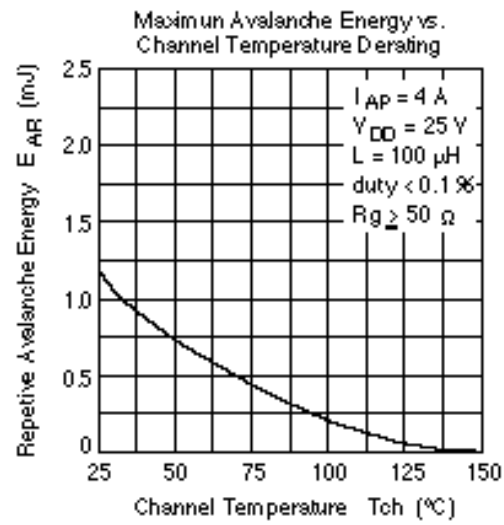
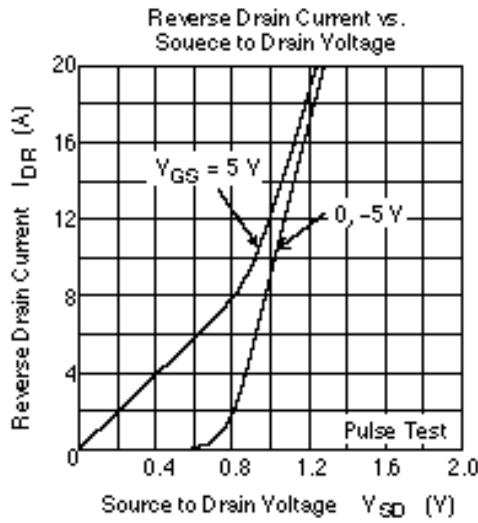


Note 6 :
When using the glass epoxy board
(FR4 40×40×1.6 mm)

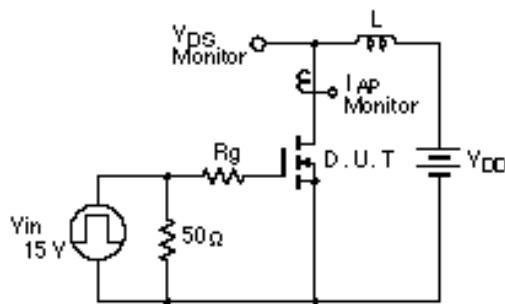






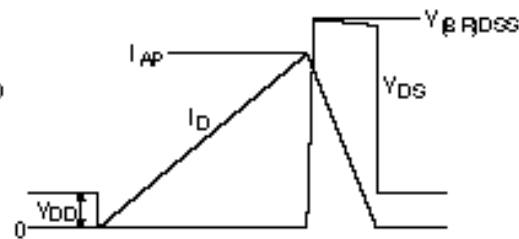


Avalanche Test Circuit

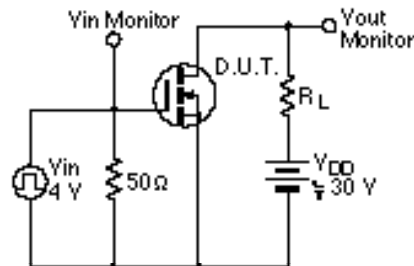


Avalanche Waveform

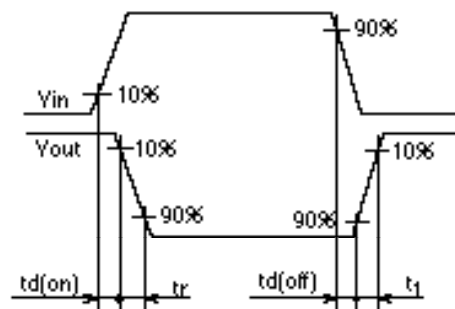
$$E_{AR} = \frac{1}{2} \cdot L \cdot I_{AP}^2 \cdot \frac{V_{DSS}}{V_{DSS} - V_{DD}}$$

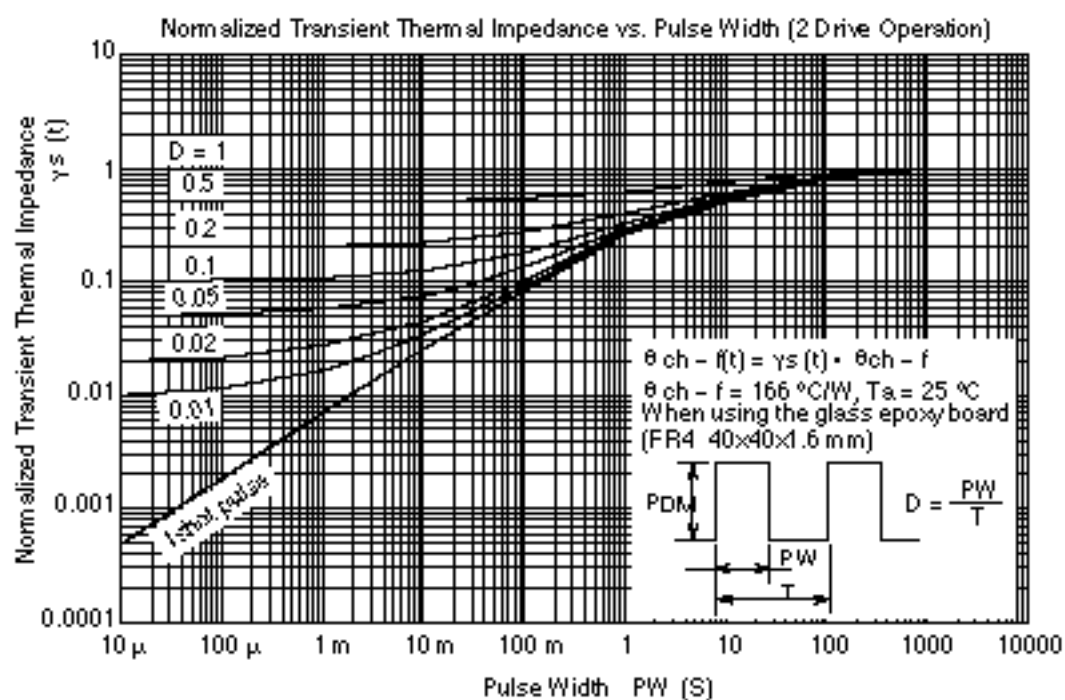
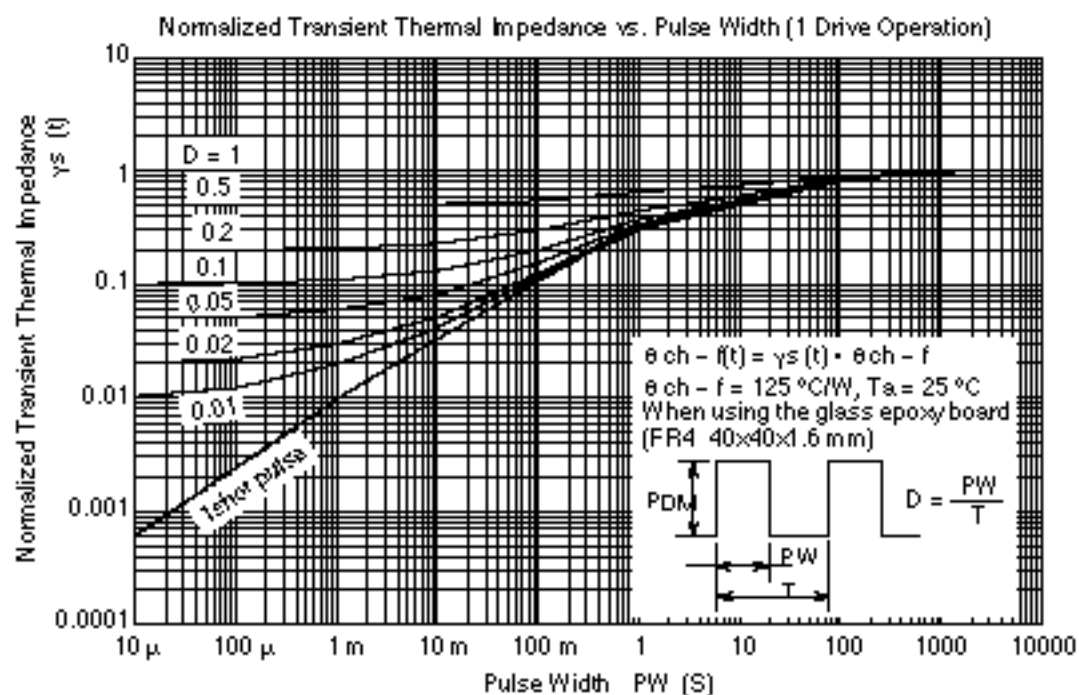


Switching Time Test Circuit



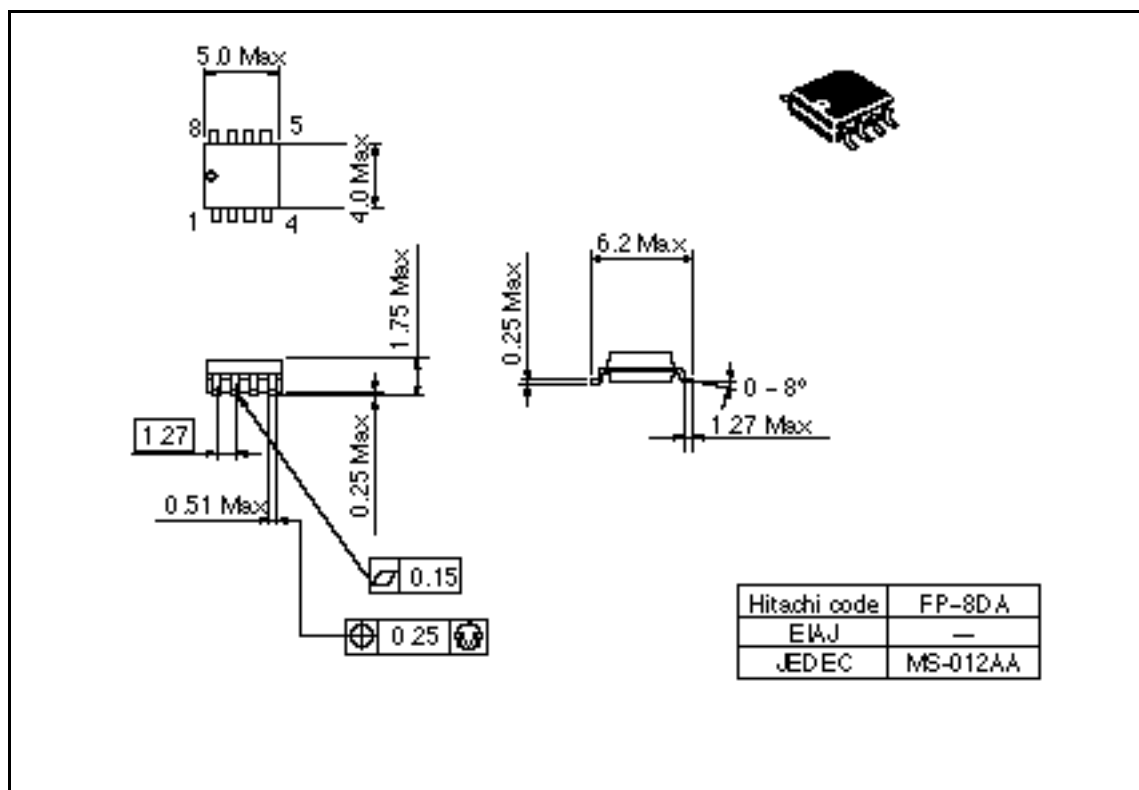
Switching Time Waveform





Package Dimensions

Unit: mm



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